High Performance Communication Buffer

General Description

The **ICS91305** is a high performance, low skew, low jitter clock driver. It uses a phase lock loop (PLL) technology to align, in both phase and frequency, the REF input with the CLKOUT signal. It is designed to distribute high speed clocks in communication systems operating at speeds from 10 to 133 MHz.

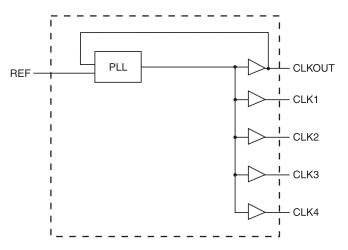
ICS91305 is a zero delay buffer that provides synchronization between the input and output. The synchronization is established via CLKOUT feed back to the input of the PLL. Since the skew between the input and output is less than +/-350 pS, the part acts as a zero delay buffer.

The **ICS91305** comes in an eight pin 150 mil SOIC package. It has five output clocks. In the absence of REF input, will be in the power down mode. In this mode, the PLL is turned off and the output buffers are pulled low. Power down mode provides the lowest power consumption for a standby condition.

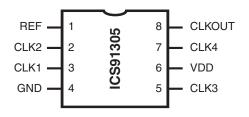
Features

- Zero input output delay
- Frequency range 10 133 MHz (3.3V)
- 5V tolerant input REF
- High loop filter bandwidth ideal for Spread Spectrum applications.
- Less than 200 ps Jitter between outputs
- Skew controlled outputs
- Skew less than 250 ps between outputs
- Available in 8 pin 150 mil SOIC & 173 mil TSSOP packages
- 3.3V ±10% operation

Block Diagram



Pin Configuration



8 pin SOIC & TSSOP

Pin Descriptions

PIN NUMBER	PIN NAME	ТҮРЕ	DESCRIPTION
1	REF ²	IN	Input reference frequency, 5V tolerant input.
2	CLK2 ³	OUT	Buffered clock output
3	CLK1 ³	OUT	Buffered clock output
4	GND	PWR	Ground
5	CLK3 ³	OUT	Buffered clock output
6	VDD	PWR	Power Supply (3.3V)
7	CLK4 ³	OUT	Buffered clock output
8	CLKOUT ³	OUT	Buffered clock output. Internal feedback on this pin

Notes:

1. Guaranteed by design and characterization. Not subject to 100% test.

2. Weak pull-down

3. Weak pull-down on all outputs

Absolute Maximum Ratings

Supply Voltage	7.0 V
Logic Inputs (Except REF)	GND –0.5 V to V _{DD} + 0.5 V
Logic Input REF	GND –0.5 V to GND + 5.5 V
Ambient Operating Temperature	0°C to +70°C
Storage Temperature	–65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Electrical Characteristics at 3.3V

 V_{DD} = 3.0 – 3.6 V, T_A = 0 – 70 $^{\circ}$ C unless otherwise stated

		DC Characteristics				
PARAMETER	SYMBOL	TEST CONDITIONS MIN		TYP	MAX	UNITS
Input Low Voltage	V _{IL}				0.8	V
Input High Voltage	V _{IH}		2.0			V
Input Low Current	IIL	$V_{IN} = 0V$		19	50.0	μA
Input High Current	I _{IH}	$V_{IN} = V_{DD}$		0.10	100.0	μA
Output Low Voltage ¹	V _{OL}	I _{OL} = 25mA		0.25	0.4	V
Output High Voltage ¹	V _{OH}	I _{OH} = 25mA	2.4	2.9		V
Power Down Supply Current	I _{DD}	REF = 0 MHz		0.3	50.0	μA
Supply Current	I _{DD}	Unloaded oututs at 66.66 MHz SEL inputs at V_{DD} or GND		30.0	40.0	mA

Notes:

1. Guaranteed by design and characterization. Not subject to 100% test.

2. All Skew specifications are mesured with a 50Ω transmission line, load teminated with 50Ω to 1.4V.

3. Duty cycle measured at 1.4V.

4. Skew measured at 1.4V on rising edges. Loading must be equal on outputs.

SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
t1	With CL = 30pF	100.00 (10)		7.5 (133)	ns (MHz)
t1	With CL = 30pF	100.00 (10)		7.5 (133)	ns (MHz)
Dt1	Measured at 1.4V; CL = 30pF	40.0	50	60	%
Dt2	Measured at VDD/2 Fout <66.6MHz	45	50	55	%
tr1	Measured between 0.8V and 2.0V: CL=30pF		1.2	1.5	ns
tf1	Measured between 2.0V and 0.8V; CL=30pF		1.2	1.5	ns
tr1	Measured between 0.8V and 2.0V: CL=5pF	1			ns
tf1	Measured between 2.0V and 0.8V; CL=5pF	1			ns
Dr1	Measured at 1.4V		0	±350	ps
Tskew	All outputs equally loaded, CL = 20pF			250	ps
Tdsk-Tdsk	Measured at VDD/2 on the CLKOUT pins of devices		0	700	ps
Тсус-Тсус	Measured at 66.66 MHz, loaded outputs			200	ps
tLOCK	Stable power supply, valid clock presented on REF pin			1.0	ms
Tjabs	@ 10,000 cycles CL = 30pF	-100	70	100	ps
Tj1s	@ 10,000 cycles CL = 30pF		14	30	ps
	t1 t1 Dt1 Dt2 tr1 tf1 tf1 tf1 Tskew Tdsk-Tdsk Tcyc-Tcyc tLOCK Tjabs	t1With CL = 30pFt1With CL = 30pFDt1Measured at 1.4V; CL = 30pFDt2Measured at VDD/2 Fout <66.6MHz	t1With $CL = 30pF$ 100.00 (10)t1With $CL = 30pF$ 100.00 (10)Dt1Measured at 1.4V; $CL = 30pF$ 40.0Dt2Measured at VDD/2 Fout <66.6MHz	t1With $CL = 30pF$ 100.00 (10)t1With $CL = 30pF$ 100.00 (10)Dt1Measured at 1.4V; $CL = 30pF$ 40.0Dt2Measured at VDD/2 Fout <66.6MHz	t1 With $CL = 30pF$ 100.00 (10) 7.5 (133) t1 With $CL = 30pF$ 100.00 (10) 7.5 (133) Dt1 Measured at 1.4V; $CL = 30pF$ 40.0 50 60 Dt2 Measured at VDD/2 Fout <66.6MHz

Switching Characteristics

Notes:

1. Guaranteed by design and characterization. Not subject to 100% test.

2. REF input has a threshold voltage of 1.4V

3. All parameters expected with loaded outputs

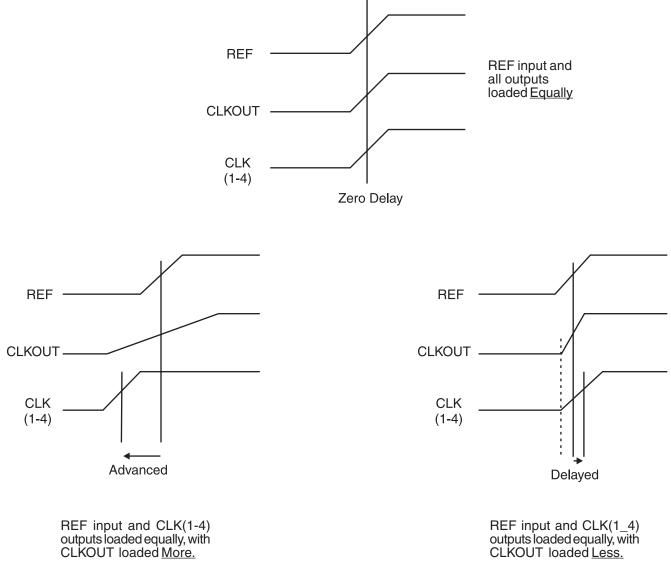
Output to Output Skew

The skew between CLKOUT and the CLK(1-4) outputs is not dynamically adjusted by the PLL. Since CLKOUT is one of the inputs to the PLL, zero phase difference is maintained from REF to CLKOUT. If all outputs are equally loaded, zero phase difference will maintained from REF to all outputs.

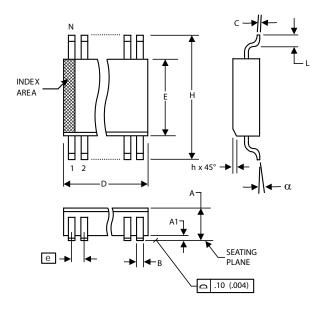
If applications requiring zero output-output skew, all the outputs must equally loaded.

If the CLK(1-4) outputs are less loaded than CLKOUT, CLK(1-4) outputs will lead it; and if the CLK(1-4) is more loaded than CLKOUT, CLK(1-4) will lag the CLKOUT.

Since the CLKOUT and the CLK(1-4) outputs are identical, they all start at the same time, but different loads cause them to have different rise times and different times crossing the measurement thresholds.



Timing diagrams with different loading configurations



150 mil (Narrow Body) SOIC

150 mil (Narrow Body) SOIC						
	In Millimeters		In Inches			
SYMBOL	COMMON D	IMENSIONS	COMMON D	DIMENSIONS		
	MIN	MAX	MIN	MAX		
A	1.35	1.75	.0532	.0688		
A1	0.10	0.25	.0040	.0098		
В	0.33	0.51	.013	.020		
С	0.19	0.25	.0075	.0098		
D	SEE VARIATIONS		SEE VARIATIONS			
E	3.80	4.00	.1497	.1574		
е	1.27 E	BASIC	0.050 BASIC			
Н	5.80	6.20	.2284	.2440		
h	0.25	0.50	.010	.020		
L	0.40	1.27	.016	.050		
N	SEE VARIATIONS		SEE VAF	RIATIONS		
α	0° 8° 0° 8°		8°			

VARIATIONS

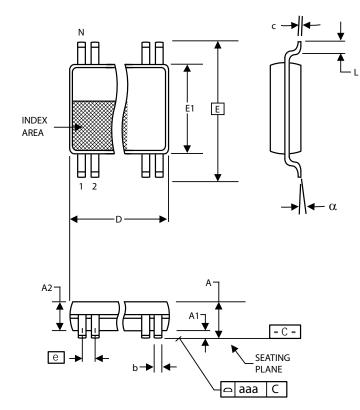
Ν	D mm.		D (inch)		
IN	MIN	MAX	MIN	MAX	
8	4.80	5.00	.1890	.1968	
Reference Doc.: JEDEC Publication 95, MS-012					

10-0030

Ordering Information

91305<u>y</u>MLFT





	4.40 mm. Bo	ody, 0.65 mm. F	Pitch TSSOP		
	(173 mil)	(25.6 mil)			
	In Milli	meters	In In	ches	
SYMBOL	COMMON DIMENSIONS		COMMON DIMENSIONS		
	MIN	MAX	MIN	MAX	
A		1.20		.047	
A1	0.05	0.15	.002	.006	
A2	0.80	1.05	.032	.041	
b	0.19	0.30	.007	.012	
С	0.09	0.20	.0035	.008	
D	SEE VAF	RIATIONS	SEE VAF	RIATIONS	
E	6.40 E	BASIC	0.252	BASIC	
E1	4.30	4.50	.169	.177	
е	0.65 E	BASIC	0.0256 BASIC		
L	0.45	0.75	.018	.030	
N	SEE VAF	RIATIONS	SEE VARIATIONS		
а	0°	8°	0°	8°	
aaa		0.10		.004	

VARIATIONS

Ν	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
8	2.90	3.10	.114	.122

Reference Doc.: JEDEC Publication 95, MO-153

10-0035

Ordering Information

91305<u>y</u>GLFT





Revision History

Rev.	Issue Date	Description	Page #
G	8/6/2007	Updated Rise/Fall Time.	4
Н	12/2/2008	Removed ICS prefix from ordering information	6-7

IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers skilled in the art designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only for development of an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising out of your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Rev.1.0 Mar 2020)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit: www.renesas.com/contact/